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SPECIFICATIONS FOR LCD MODULE

CUSTOMER	
CUSTOMER PART NO.	
ACMMI PART NO.	AMG16032A
DESCRIPTION	
APPROVED BY	
DATE	

PREPARED BY	CHECKED BY	APPROVED BY

DOCUMENT REVISION HISTORY:

DATE	PAGE	DESCRIPTION
2000.8.	-	First release
2005.3.	-	Modify the full specification
2005.12	4	Update the part number system

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1. Module Classification Information

A M C 1 6 0 2 A R - B - B 6 W T D W - S P
 1 2 3 4 5 6 7 8 9 10 11 12 13

1	Brand : Orient Display (N.A.) Ltd.	
2	Display Type : C→ Character Type, G→ Graphic Type, NONE→ Custom-made	
3	Display Font : Characters X Lines / Rows X Columns /Others	
4	Model serials no.	
5	RoHS compliant: R→YES NONE→ NO	
6	IC Package Type:	M→ SMT Type B→ COB Type T→ TAB Type G→ COG Type F→ COF Type S→ Special
7	LCD Mode:	P→TN Positive N→TN Negative Y→ STN Positive, Yellow Green B→ STN Negative, Blue G→ STN Positive, Gray W→ FSTN Positive T→ FSTN Negative F→ FFSTN Negative S→ Special
8	Viewing direction	6→ 6:00,12→12:00, S→Special
9	Temperature range	N → Normal Temperature W→ Wide Temperature S→ Special
10	LCD Polarizer Type	R→ Reflective T→ Transmissive F→ Transflective S→ Special
11	Backlight Type	N→ None D→ LED E→ EL F→ CCFL S→ Special
12	Backlight Color	Y→ Yellow-green B→ Blue A→ Amber W→ White G→ Green R→ Red S→ Special
13	Internal Code	

2. Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.

3. General Specification

Item	Dimension	Unit
Number of Dots	160 x 32	—
Module dimension(No Backlight)	84.0 x 44.0 x 14.0 (MAX)	mm
Module dimension(With LED Backlight)	84.0 x 44.0 x 14.0 (MAX)	mm
View area	60.5 x 18.5	mm
Active area	52.77 x 12.13	mm
Dot size	0.30x 0.35	mm
Dot pitch	0.33 x 0.38	mm
LCD type	STN	
Duty	1/32	
View direction	6 o'clock or 12 o'clock	
Backlight Type	None, YELLOW-GREEN backlight	

4. Absolute Maximum Ratings

Item		Symbol	Min	Max	Unit
Input Voltage		V_I	-0.3	$V_{DD}+0.3$	V
Supply Voltage For Logic		$V_{DD}-V_{SS}$	-0.3	7.0	V
Supply Voltage For LCD		$V_{DD}-V_0$	$V_{dd}-13.5$	0	V
Standard	Operating Temp.	Top	0	50	°C
Temperature LCM	Storage Temp.	Tstr	-10	60	°C
Wide Temperature	Operating Temp.	Top	-20	70	°C
LCM	Storage Temp.	Tstr	-30	80	°C

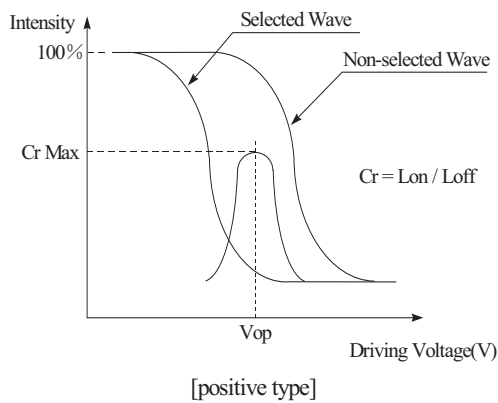
5. Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage For Logic	$V_{DD}-V_{SS}$	—	4.5	5.0	5.5	V
Supply Voltage For LCD	$V_{DD}-V_0$	$T_a=25^{\circ}\text{C}$	4.5	4.9	5.3	V
Input High Volt.	V_{IH}	—	$0.7 V_{DD}$	—	V_{DD}	V
Input Low Volt.	V_{IL}	—	V_{SS}	—	$0.3 V_{DD}$	V
Supply Current	I_{DD}	$V_{DD}=5\text{V}$	0.7	1.2	1.6	mA
Supply Voltage of Yellow-green backlight	V_{LED}	Forward current =100 mA Number of LED die 2x10= 20	3.8	4.1	4.3	V

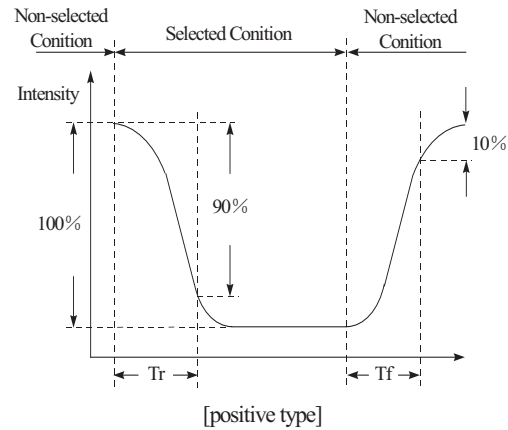
6. Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) θ	$CR \geq 2$	-20	—	35	deg
	(H) ϕ	$CR \geq 2$	-30	—	30	deg
Contrast Ratio	CR	—	—	3	—	—
Response Time	T rise	—	—	—	250	ms
	T fall	—	—	—	250	ms

Definition of Operation Voltage (Vop)



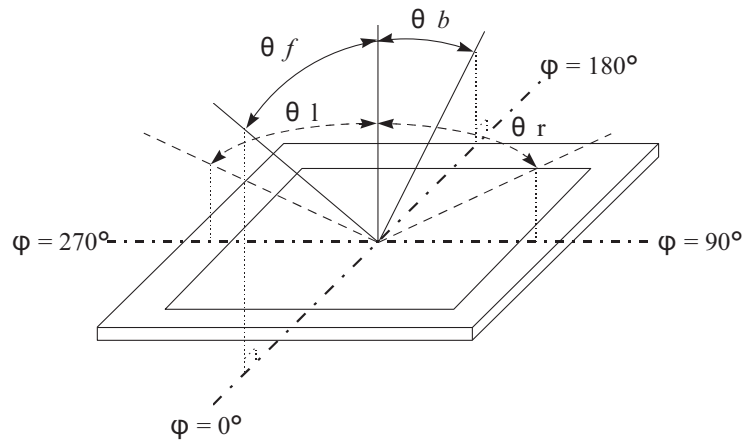
Definition of Response Time (Tr , Tf)



Conditions :

Operating Voltage : Vop Viewing Angle(θ , ϕ) : 0° , 0°
 Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias

Definition of viewing angle($CR \geq 2$)

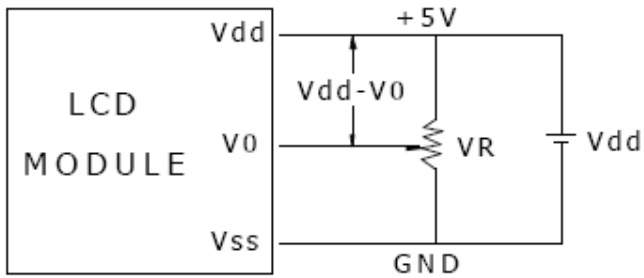


7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	V _{SS}	0V	Ground
2	V _{DD}	5.0V	Supply Voltage for logic
3	V ₀		Supply voltage for LCD
4	RS	H/L	Register Select
5	R/W	H/L	Read/Write
6	E	H/L	Enable
7	DB0	H/L	Data bit 0
8	DB1	H/L	Data bit 1
9	DB2	H/L	Data bit 2
10	DB3	H/L	Data bit 3
11	DB4	H/L	Data bit 4
12	DB5	H/L	Data bit 5
13	DB6	H/L	Data bit 6
14	DB7	H/L	Data bit 7
15	NC		NC
16	RST	H/L	Reset Signal
17	LED(+)		Anode of LED Backlight
18	LED(-)		Cathode of LED Backlight

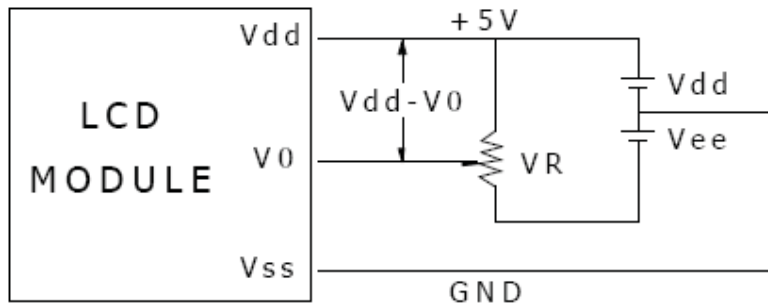
8. POWER SUPPLY

SINGLE SUPPLY VOLTAGE TYPE (for LCM with Negative Power on PCB)



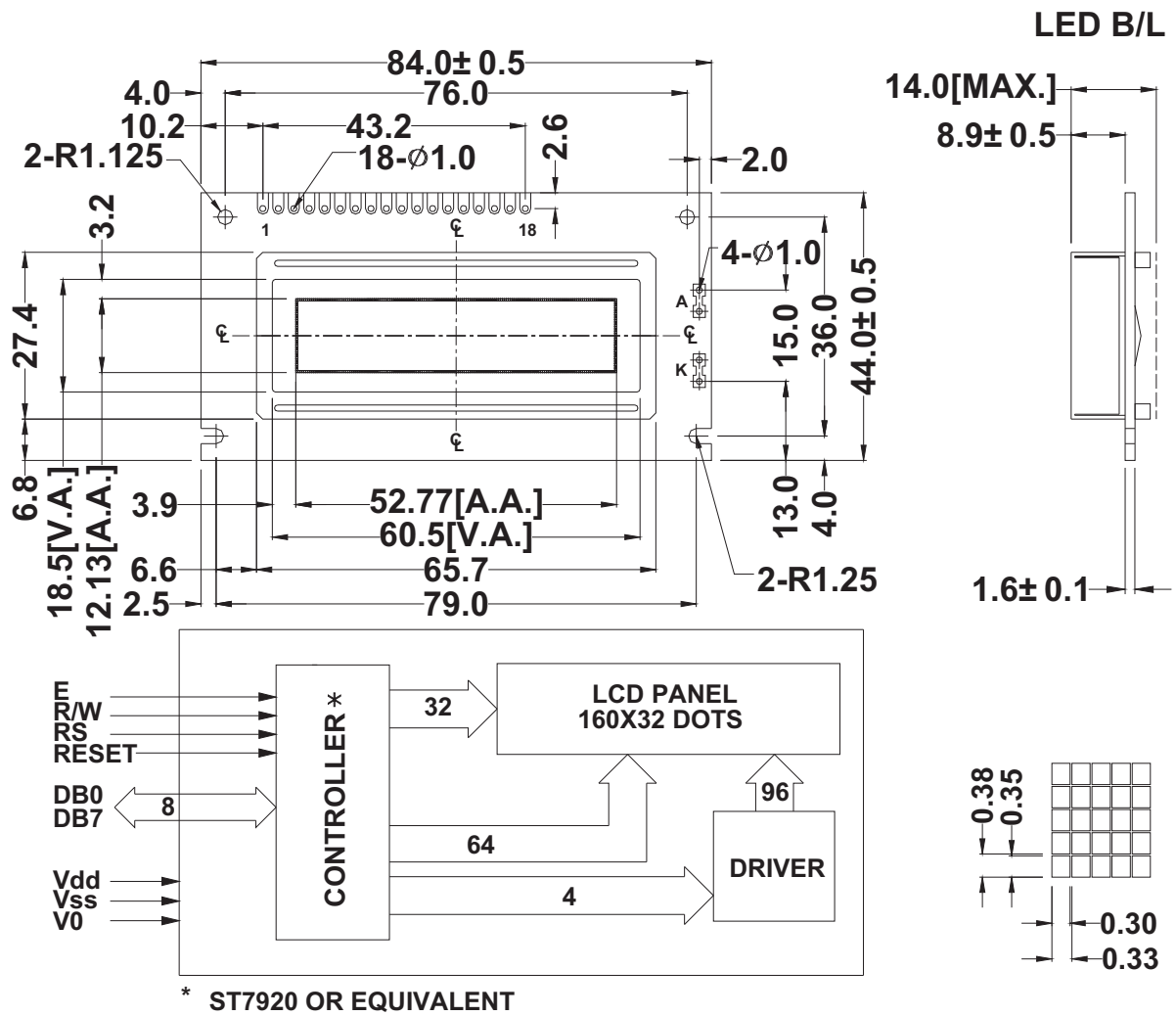
Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

DUAL SUPPLY VOLTAGE TYPE (for LCM without Negative Power on PCB)



Vdd-V0: LCD Driving Voltage
VR: 10K - 20K

9. Contour Drawing & Block Diagram



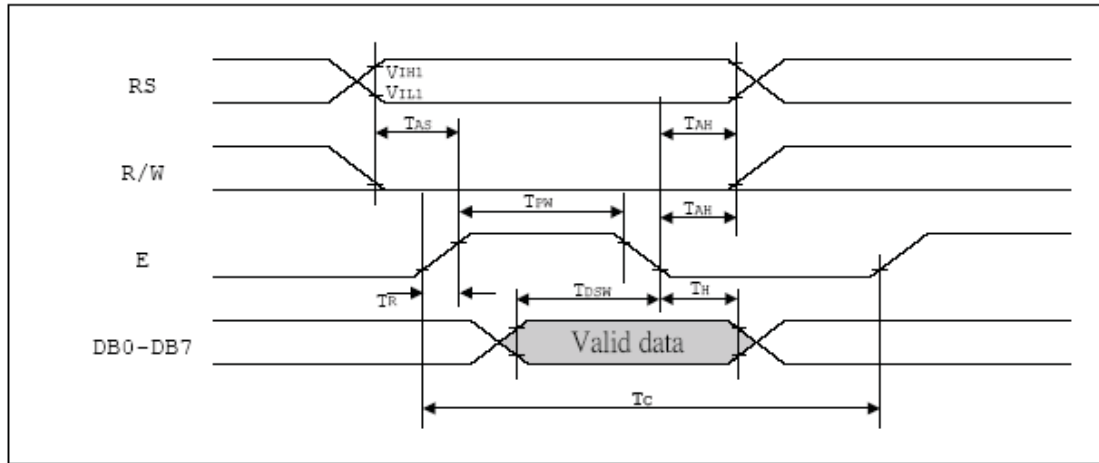
10. Timing Characteristics

AC Characteristics ($T_A = 25^\circ\text{C}$, $V_{DD} = 4.5\text{V}$) Parallel Mode Interface

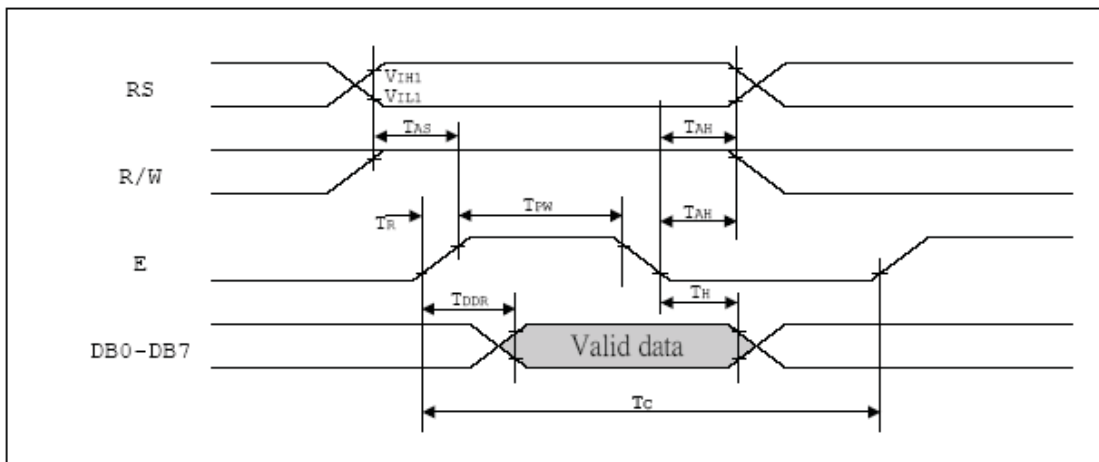
Symbol	Characteristics	Test Condition	Min.	Typ.	Max.	Unit
<i>Internal Clock Operation</i>						
f_{OSC}	OSC Frequency	$R = 33\text{K}\Omega$	480	540	600	KHz
<i>External Clock Operation</i>						
f_{EX}	External Frequency	-	480	540	600	KHz
	Duty Cycle	-	45	50	55	%
T_R, T_F	Rise/Fall Time	-	-	-	0.2	μs
<i>Write Mode (Writing data from MPU to ST7920)</i>						
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS, RW, E	10	-	-	ns
T_{AH}	Address Hold Time	Pins: RS, RW, E	20	-	-	ns
T_{DSW}	Data Setup Time	Pins: DB0 - DB7	40	-	-	ns
T_H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Read Mode (Reading Data from ST7920 to MPU)</i>						
T_C	Enable Cycle Time	Pin E	1200	-	-	ns
T_{PW}	Enable Pulse Width	Pin E	140	-	-	ns
T_R, T_F	Enable Rise/Fall Time	Pin E	-	-	25	ns
T_{AS}	Address Setup Time	Pins: RS, RW, E	10	-	-	ns
T_{AH}	Address Hold Time	Pins: RS, RW, E	20	-	-	ns
T_{DDR}	Data Delay Time	Pins: DB0 - DB7	-	-	100	ns
T_H	Data Hold Time	Pins: DB0 - DB7	20	-	-	ns
<i>Interface Mode with LCD Driver(ST7921)</i>						
T_{CWH}	Clock Pulse with High	Pins: CL1, CL2	800	-	-	ns
T_{CWL}	Clock Pulse with Low	Pins: CL1, CL2	800	-	-	ns
T_{CST}	Clock Setup Time	Pins: CL1, CL2	500	-	-	ns
T_{SU}	Data Setup Time	Pin: D	300	-	-	ns
T_{DH}	Data Hold Time	Pin: D	300	-	-	ns
T_{DM}	M Delay Time	Pin: M	-1000	-	1000	ns

8 bit interface timing diagram

- MPU write data to ST7920



- MPU read data from ST7920



11. Instruction Table

Instruction set 1: (RE=0: basic instruction)

Ins	code										Description	Exec time (540KHZ)
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
CLEAR	0	0	0	0	0	0	0	0	0	1	Fill DDRAM with "20H", and set DDRAM address counter (AC) to "00H"	1.6 ms
HOME	0	0	0	0	0	0	0	0	0	X	Set DDRAM address counter (AC) to "00H", and put cursor to origin ; the content of DDRAM are not changed	72us
ENTRY MODE	0	0	0	0	0	0	0	1	I/D	S	Set cursor position and display shift when doing write or read operation	72us
DISPLAY ON/OFF	0	0	0	0	0	0	1	D	C	B	D=1: display ON C=1: cursor ON B=1: blink ON	72 us
CURSOR DISPLAY CONTROL	0	0	0	0	0	1	S/C	R/L	X	X	Cursor position and display shift control ; the content of DDRAM are not changed	72 us
FUNCTION SET	0	0	0	0	1	DL	X	0 RE	X	X	DL=1 8-BIT interface DL=0 4-BIT interface <u>RE=1: extended instruction</u> <u>RE=0: basic instruction</u>	72 us
SET CGRAM ADDR.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address to address counter (AC) <u>Make sure that in extended instruction SR=0 (scroll or RAM address select)</u>	72 us
SET DDRAM ADDR.	0	0	1	0 AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address to address counter (AC) AC6 is fixed to 0	72 us
READ BUSY FLAG (BF) & ADDR.	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Read busy flag (BF) for completion of internal operation, also Read out the value of address counter (AC)	0 us
WRITE RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data to internal RAM (DDRAM/CGRAM/IRAM/GDRAM)	72 us
READ RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM/IRAM/GDRAM)	72 us

Instruction set 2: (RE=1: extended instruction)

Inst.	code										description	Exec. time (540KHZ)
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		
STAND BY	0	0	0	0	0	0	0	0	0	1	Enter stand by mode, any other instruction can terminate (Com1..32 halted, only Com33 ICON can display)	72 us
SCROLL or RAM ADDR. SELECT	0	0	0	0	0	0	0	0	1	SR	SR=1: enable vertical scroll position SR=0: enable IRAM address (extended instruction) SR=0: enable CGRAM address(basic instruction)	72 us
REVERSE	0	0	0	0	0	0	0	1	R1	R0	Select 1 out of 4 line (in DDRAM) and decide whether to reverse the display by toggling this instruction R1,R0 initial value is 00	72 us
SLEEP	0	0	0	0	0	0	1	SL	X	X	SL=1: leave sleep mode SL=0: enter sleep mode	72 us
EXTENDED FUNCTION SET	0	0	0	0	1	DL	X	1 RE	G	0	DL=1 8-BIT interface DL=0 4-BIT interface RE=1: extended instruction set RE=0: basic instruction set G=1 :graphic display ON G=0 :graphic display OFF	72 us
SET IRAM or SCROLL ADDR.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1: AC5~AC0 the address of vertical scroll SR=0: AC3~AC0 the address of ICON RAM	72 us
SET GRAPHIC RAM ADDR.	0	0	1	0 AC6	0 AC5	0 AC4	AC3	AC2	AC1	AC0	Set GDRAM address to address counter (AC) First set vertical address and the horizontal address by consecutive writing Vertical address range AC6...AC0 Horizontal address range AC3...AC0	72 us

Note :

1. Make sure that ST7920 is not in busy state by reading the busy flag before sending instruction or data. If use delay loop instead please make sure the delay time is enough. Please refer to the instruction execution time.
2. "RE" is the selection bit of basic and extended instruction set. Each time when altering the value of RE it will remain. There is no need to set RE every time when using the same group of instruction set.

12.Quality Assurance

Screen Cosmetic Criteria

Item	Defect	Judgment Criterion	Partition																				
1	Spots	A)Clear <table><tr><th>Size: d mm</th><th>Acceptable Qty in active area</th></tr><tr><td>$d \leq 0.1$</td><td>Disregard</td></tr><tr><td>$0.1 < d \leq 0.2$</td><td>6</td></tr><tr><td>$0.2 < d \leq 0.3$</td><td>2</td></tr><tr><td>$0.3 < d$</td><td>0</td></tr></table> Note: Including pin holes and defective dots which must be within one pixel size. B)Unclear <table><tr><th>Size: d mm</th><th>Acceptable Qty in active area</th></tr><tr><td>$d \leq 0.2$</td><td>Disregard</td></tr><tr><td>$0.2 < d \leq 0.5$</td><td>6</td></tr><tr><td>$0.5 < d \leq 0.7$</td><td>2</td></tr><tr><td>$0.7 < d$</td><td>0</td></tr></table>	Size: d mm	Acceptable Qty in active area	$d \leq 0.1$	Disregard	$0.1 < d \leq 0.2$	6	$0.2 < d \leq 0.3$	2	$0.3 < d$	0	Size: d mm	Acceptable Qty in active area	$d \leq 0.2$	Disregard	$0.2 < d \leq 0.5$	6	$0.5 < d \leq 0.7$	2	$0.7 < d$	0	Minor
Size: d mm	Acceptable Qty in active area																						
$d \leq 0.1$	Disregard																						
$0.1 < d \leq 0.2$	6																						
$0.2 < d \leq 0.3$	2																						
$0.3 < d$	0																						
Size: d mm	Acceptable Qty in active area																						
$d \leq 0.2$	Disregard																						
$0.2 < d \leq 0.5$	6																						
$0.5 < d \leq 0.7$	2																						
$0.7 < d$	0																						
2	Bubbles in Polarizer	<table><tr><th>Size: d mm</th><th>Acceptable Qty in active area</th></tr><tr><td>$d \leq 0.3$</td><td>Disregard</td></tr><tr><td>$0.3 < d \leq 1.0$</td><td>3</td></tr><tr><td>$1.0 < d \leq 1.5$</td><td>1</td></tr><tr><td>$1.5 < d$</td><td>0</td></tr></table>	Size: d mm	Acceptable Qty in active area	$d \leq 0.3$	Disregard	$0.3 < d \leq 1.0$	3	$1.0 < d \leq 1.5$	1	$1.5 < d$	0	Minor										
Size: d mm	Acceptable Qty in active area																						
$d \leq 0.3$	Disregard																						
$0.3 < d \leq 1.0$	3																						
$1.0 < d \leq 1.5$	1																						
$1.5 < d$	0																						
3	Scratch	In accordance with spots cosmetic criteria. When the light reflects on the panel surface, the scratches are not to be remarkable.	Minor																				
4	Allowable Density	Above defects should be separated more than 30mm each other.	Minor																				
5	Coloration	Not to be noticeable coloration in the viewing area of the LCD panels. Back-light type should be judged with back-light on state only.	Minor																				

13. Reliability

Content of Reliability Test

Environmental Test			
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	60℃ 96hrs	—
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-10℃ 96hrs	—
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	50℃ 96hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	0℃ 96hrs	—
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60℃, 90%RH 96hrs	—
High Temperature/ Humidity Operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	50℃, 90%RH 96hrs	—
Temperature Cycle	Endurance test applying the low and high temperature cycle. -10℃ 25℃ 60℃ 30min 5min 30min 1 cycle	-10℃/60℃ 10 cycles	—
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hrs	—
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sign wave 11 msdc 3 times of each direction	—

***Supply voltage for logic system=5V. Supply voltage for LCD system =Operating voltage at 25℃